
2SJ317

Silicon P-Channel MOS FET

HITACHI

ADE-208-1191 (Z)

1st. Edition

Mar. 2001

Application

High speed power switching

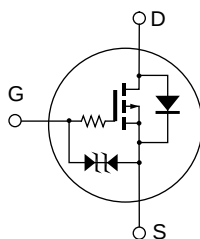
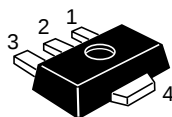
Low voltage operation

Features

- Very low on-resistance
- High speed switching
- Suitable for camera or VTR motor drive circuit, power switch, solenoid drive and etc.

Outline

UPAK



1. Gate
2. Drain
3. Source
4. Drain

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	-12	V
Gate to source voltage	V_{GSS}	-7	V
Drain current	I_D	±2	A
Drain peak current	$I_{D(pulse)}^{*1}$	±4	A
Body to drain diode reverse drain current	I_{DR}	2	A
Channel dissipation	P_{ch}^{*2}	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

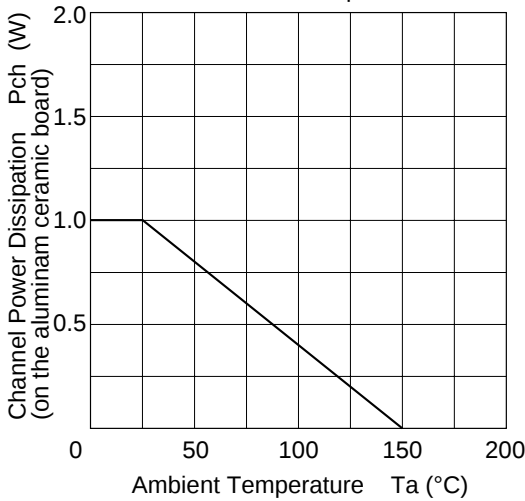
Notes: 1. PW 100 μs, duty cycle 10%
 2. Value on the alumina ceramic board (12.5×20×0.7 mm).
 3. Marking is "NY".

Electrical Characteristics (Ta = 25°C)

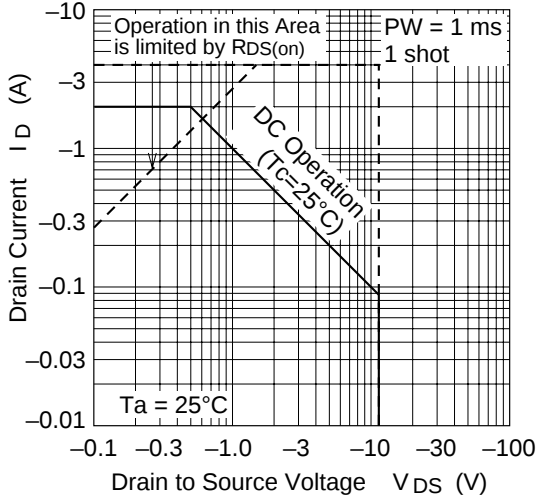
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-12	—	—	V	$I_D = -1 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±7	—	—	V	$I_G = \pm 10 \text{ } \mu\text{A}$, $V_{DS} = 0$
Gate to source cutoff current	I_{GSS}	—	—	±5	μA	$V_{GS} = \pm 6.5 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-1	μA	$V_{DS} = -8 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-0.4	—	-1.4	V	$I_D = -100 \text{ } \mu\text{A}$, $V_{DS} = -5 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)1}$	—	0.4	0.7		$I_D = -0.5 \text{ A}^{*1}$, $V_{GS} = -2.2 \text{ V}$
	$R_{DS(on)2}$	—	0.28	0.35		$I_D = -1 \text{ A}^{*1}$, $V_{GS} = -4 \text{ V}$
Forward transfer admittance	$ y_{fs} $	1.0	2.3	—	S	$I_D = -1 \text{ A}^{*1}$, $V_{DS} = -5 \text{ V}$
Input capacitance	Ciss	—	63	—	pF	$V_{DS} = -5 \text{ V}$, $V_{GS} = 0$,
Output capacitance	Coss	—	180	—	pF	f = 1 MHz
Reverse transfer capacitance	Crss	—	23	—	pF	
Turn-on time	t_{on}	—	500	—	ns	$I_D = -0.2 \text{ A}^{*1}$, $V_{in} = -4 \text{ V}$,
Turn-off time	t_{off}	—	2860	—	ns	$R_L = 51$

Note: 1. Pulse test

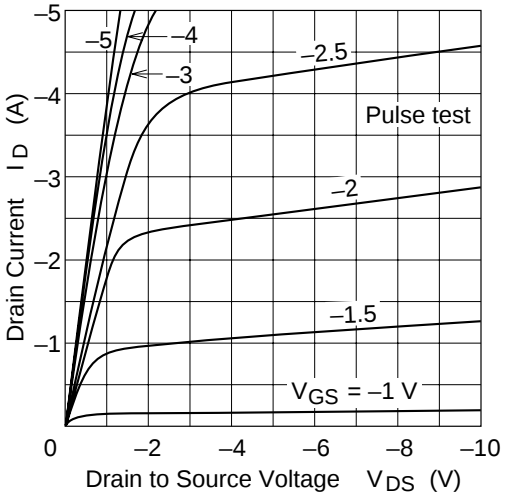
Maximun Power Dissipation Curve



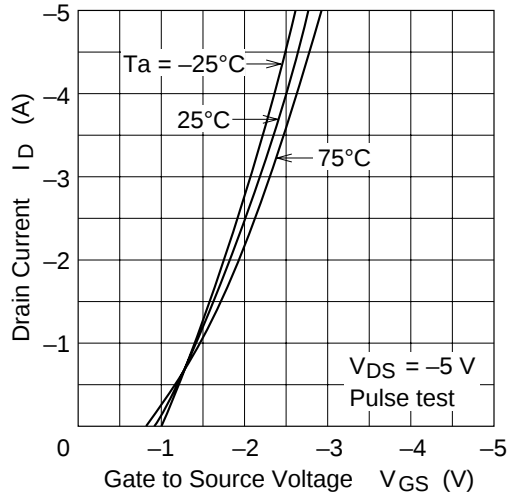
Maximun Safe Operation Area



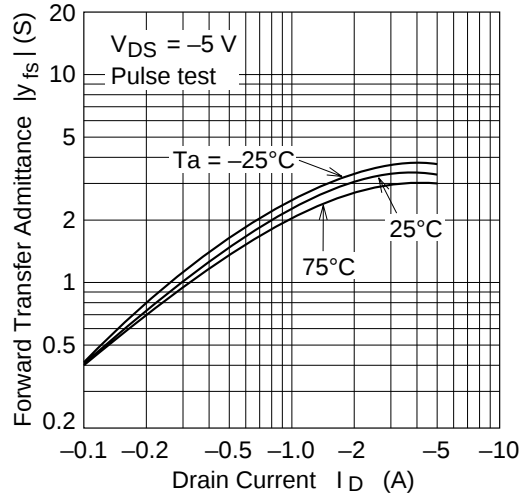
Typical Output Characteristics



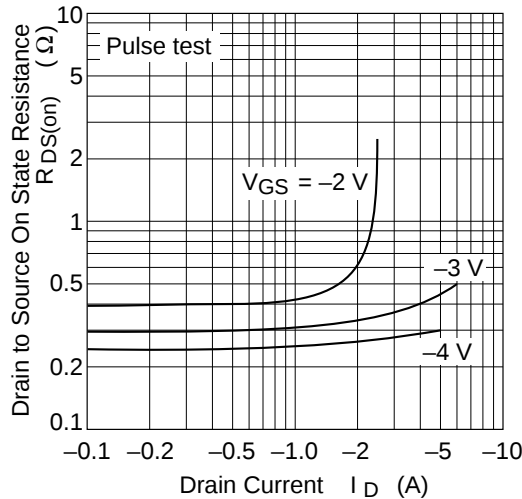
Typical Forward Transfer Characteristics



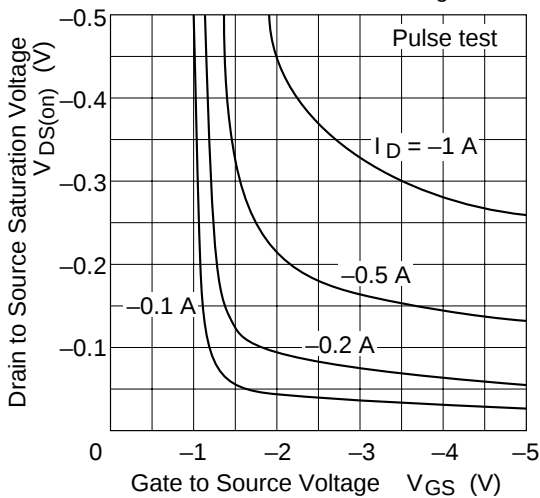
Forward Transfer Admittance vs.
Drain Current



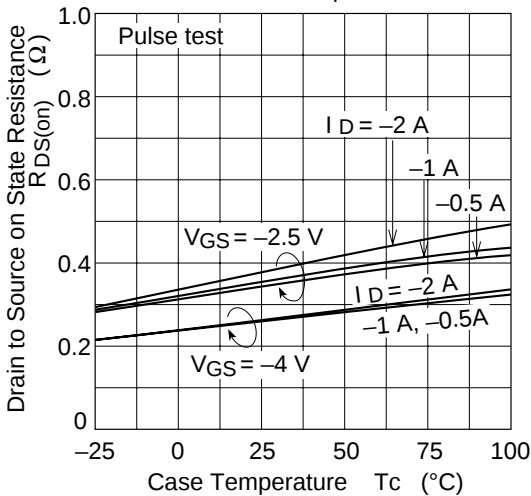
Drain to Source on State Resistance
vs. Drain Current



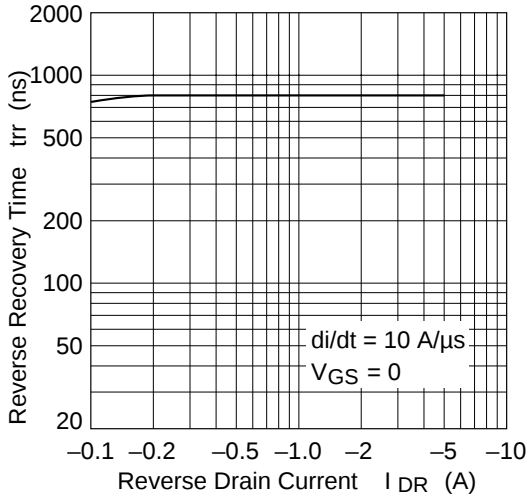
Drain to Source Saturation Voltage
vs. Gate to Source Voltage



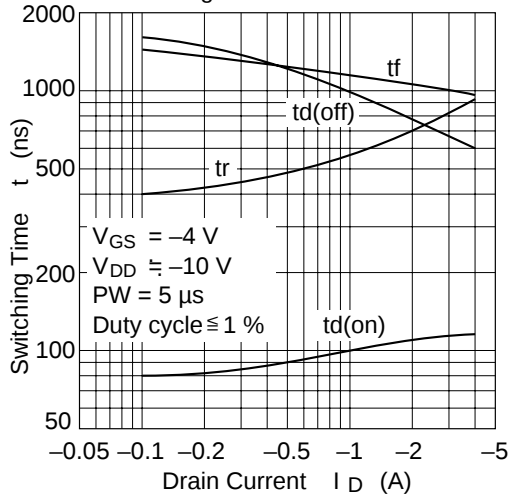
Drain to Source on State Resistance
vs. Case Temperature



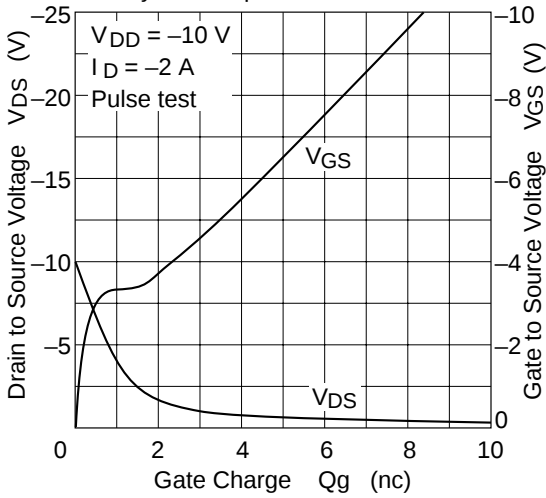
Reverse Recovery Time vs.
Reverse Drain Current



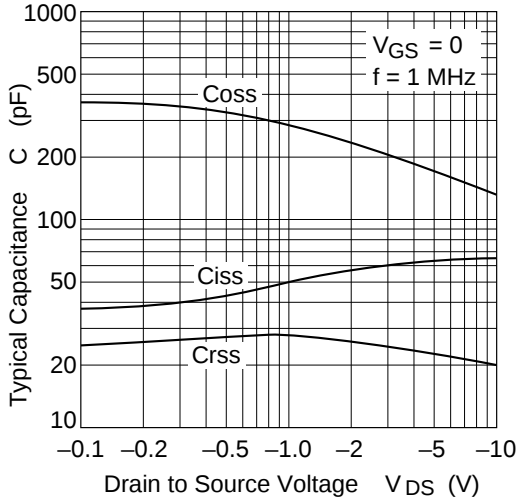
Switching Time vs. Drain Current

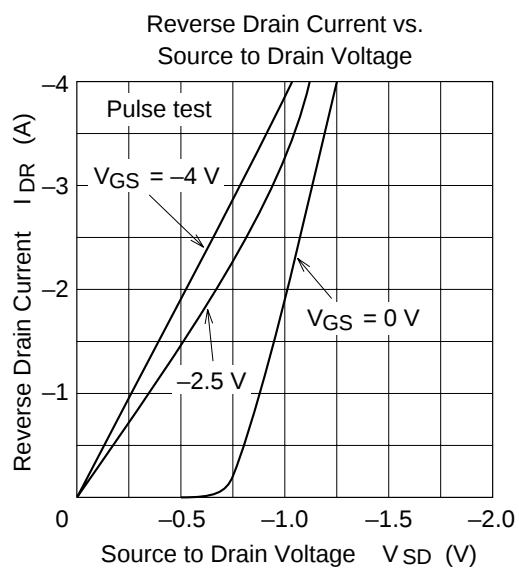


Dynamic Input Characteristics



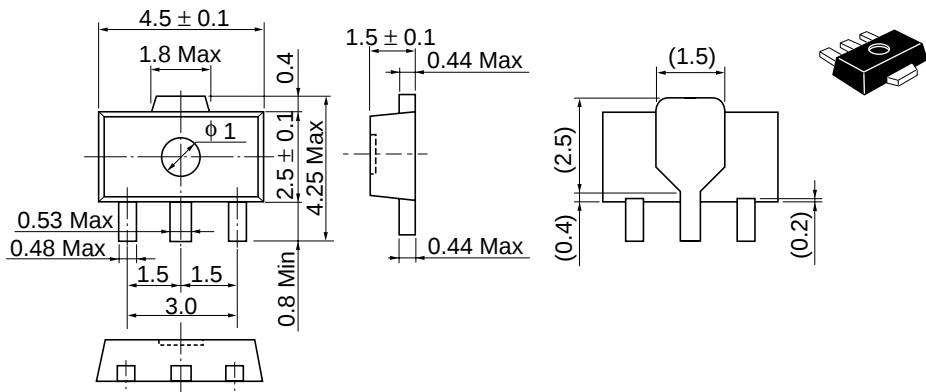
Typical Capacitance vs.
Drain to Source Voltage





Package Dimensions

As of January, 2001
Unit: mm



Hitachi Code	UPAK
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.050 g

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL	NorthAmerica	:	http://semiconductor.hitachi.com/
	Europe	:	http://www.hitachi-eu.com/hel/ecg
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1> (408) 433-0223

Hitachi Europe GmbH
Electronic Components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 585160

Hitachi Asia Ltd.
Hitachi Tower
16 Collyer Quay #20-00,
Singapore 049318
Tel: <65>-538-6533/538-8577
Fax: <65>-538-6933/538-3877
URL: <http://www.hitachi.com.sg>

Hitachi Asia Ltd.
(Taipei Branch Office)
4/F, No. 167, Tun Hwa North Road,
Hung-Kuo Building,
Taipei (105), Taiwan
Tel: <886>-(2)-2718-3666
Fax: <886>-(2)-2718-8180
Telex: 23222 HAS-TP
URL: <http://www.hitachi.com.tw>

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower,
World Finance Centre,
Harbour City, Canton Road
Tsim Sha Tsui, Kowloon,
Hong Kong
Tel: <852>-(2)-735-9218
Fax: <852>-(2)-730-0281
URL: <http://www.hitachi.com.hk>

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